

## TIS/MADRID ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.1

MADRID ID: MD236679

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| <b>SUBMISSION TYPE:</b>          | NEW ASSIGNMENT   |
| <b>NATURE OF CONVEYANCE:</b>     | ASSIGNS THE ENTIRE INTEREST AND THE GOODWILL   |
| <b>CONVEYING PARTY DATA</b>      |  |
| <b>Name</b>                      | <b>Execution Date</b>  |
| Huawei Technologies Co., Ltd.    | 04/26/2021   |
| <b>RECEIVING PARTY DATA</b>      |  |
| <b>Name:</b>                     | Honor Device Co., Ltd.   |
| <b>Address:</b>                  | Suite 3401, Unit A,<br>Building 6, Shum Yip Sky Park,<br>No. 8089, Hongli West Road,<br>Xiangmihu Street, Futian District,<br>Shenzhen<br>518040 Guangdong |
| <b>Country:</b>                  | CN   |
| <b>Entity Type:</b>              | Limited company  |
| <b>Entity Country:</b>           | The People's Republic of China   |
| <b>PROPERTY NUMBERS Total: 1</b> |  |
| <b>Property Type</b>             | <b>Number</b>  |
| <b>Serial Number:</b>            | 79253571   |
| <b>CORRESPONDENCE DATA</b>       |  |
| <b>Correspondent Name:</b>       | Honor Device Co., Ltd.   |
| <b>Address:</b>                  | Suite 3401, Unit A,<br>Building 6, Shum Yip Sky Park,<br>No. 8089, Hongli West Road,<br>Xiangmihu Street, Futian District,<br>Shenzhen<br>518040 Guangdong |
| <b>Country:</b>                  | CN   |

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